

**Abstract****An integrated circuit**

- 5 An integrated circuit connection is disclosed. The integrated circuit connection comprises a substrate 221, a first and a second transmission line 205, 203, a die 219, and a conductive ribbon 207. The first transmission line 205 has a first termination 215 and is arranged on the substrate 221. The die 219 is spaced from the first termination 215, and has a first surface which is arranged on the substrate 221 and a second
- 10 opposed surface on which the second transmission line 203 is arranged. The second transmission line 203 has a second termination 211, and the conductive ribbon 207 electrically couples the first and the second termination 215, 211. A conductive ribbon 215 for use in an integrated circuit 201 is also disclosed.

- 15 [Figure 7]